

TECHNIQUE FOR MANUFACTURING ELECTRONIC PARTS

5 ABSTRACT OF THE DISCLOSURE A technique for manufacturing electronic parts uses barrel plating to plate films on external electrodes of the electronic parts with small thickness variation of the plated films. The technique comprises disposing a plurality of non-spherical conductive elements in a plating barrel, disposing a plurality of electronic parts in the plating barrel, and rotating the plating barrel to form the plated films on the external electrodes of the electronic parts.

Figure 1



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